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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	Z8
Core Size	8-Bit
Speed	12MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	14
Program Memory Size	2KB (2K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	125 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	18-DIP (0.300", 7.62mm)
Supplier Device Package	-
Purchase URL	<a href="https://www.e-xfl.com/product-detail/zilog/z86e0812psg1866">https://www.e-xfl.com/product-detail/zilog/z86e0812psg1866</a>

## PIN DESCRIPTION

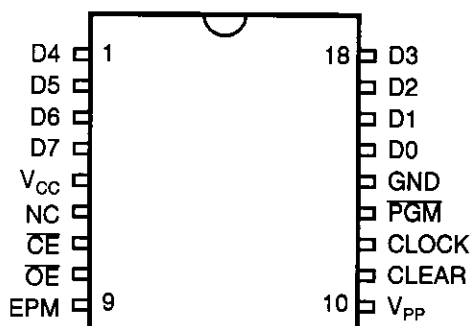


Figure 3. 18-Pin EPROM Mode Configuration

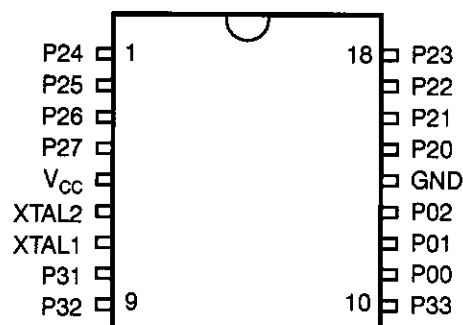


Figure 4. 18-Pin DIP/SOIC Mode Configuration

Table 1. 18-Pin DIP Pin Identification

EPROM Programming Mode			
Pin #	Symbol	Function	Direction
1–4	D4–D7	Data 4, 5, 6, 7	In/Output
5	V <sub>CC</sub>	Power Supply	
6	NC	No Connection	
7	CE	Chip Enable	Input
8	OE	Output Enable	Input
9	EPM	EPROM Prog Mode	Input
10	V <sub>PP</sub>	Prog Voltage	Input
11	Clear	Clear Clock	Input
12	Clock	Address	Input
13	PGM	Prog Mode	Input
14	GND	Ground	
15–18	D0–D3	Data 0,1, 2, 3	In/Output

Table 2. 18-Pin DIP/SOIC Pin Identification

Standard Mode			
Pin #	Symbol	Function	Direction
1–4	P24–P27	Port 2, Pins 4,5,6,7	In/Output
5	V <sub>CC</sub>	Power Supply	
6	XTAL2	Crystal Osc. Clock	Output
7	XTAL1	Crystal Osc. Clock	Input
8	P31	Port 3, Pin 1, AN1	Input
9	P32	Port 3, Pin 2, AN2	Input
10	P33	Port 3, Pin 3, REF	Input
11–13	P00–P02	Port 0, Pins 0,1,2	In/Output
14	GND	Ground	
15–18	P20–P23	Port 2, Pins 0,1,2,3	In/Output

## STANDARD TEST CONDITIONS

The characteristics listed below apply for standard test conditions as noted. All voltages are referenced to Ground. Positive current flows into the referenced pin (Figure 5).

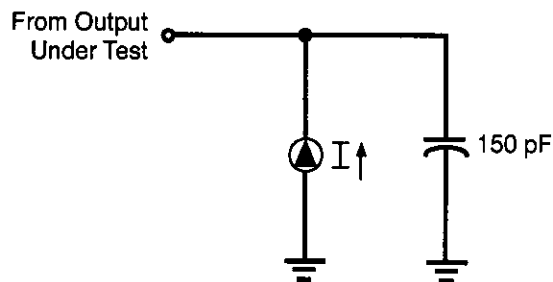


Figure 5. Test Load Diagram

## CAPACITANCE

$T_A = 25^\circ\text{C}$ ,  $V_{CC} = \text{GND} = 0\text{V}$ ,  $f = 1.0\text{ MHz}$ , unmeasured pins returned to GND.

Parameter	Min	Max
Input capacitance	0	10 pF
Output capacitance	0	20 pF
I/O capacitance	0	25 pF

Sym	Parameter	$T_A = 0^\circ\text{C to } +70^\circ\text{C}$ Typical			Units	Conditions	Notes
		$V_{CC}$ [4]	Min	Max @ 25°C			
$I_{CC}$	Supply Current	4.5V		11.0	6.8	mA All Output and I/O Pins Floating @ 2 MHz	5,7
		5.5V		11.0	6.8	mA All Output and I/O Pins Floating @ 2 MHz	5,7
		4.5V		15.0	8.2	mA All Output and I/O Pins Floating @ 8 MHz	5,7
		5.5V		15.0	8.2	mA All Output and I/O Pins Floating @ 8 MHz	5,7
		4.5V		20.0	12.0	mA All Output and I/O Pins Floating @ 12 MHz	5,7
		5.5V		20.0	12.0	mA All Output and I/O Pins Floating @ 12 MHz	5,7
$I_{CC1}$	Standby Current	4.5V		4.0	2.5	mA HALT Mode $V_{IN} = 0V$ , $V_{CC}$ @ 2 MHz	5,7
		5.5V		4.0	2.5	mA HALT Mode $V_{IN} = 0V$ , $V_{CC}$ @ 2 MHz	5,7
		4.5V		5.0	3.0	mA HALT Mode $V_{IN} = 0V$ , $V_{CC}$ @ 8 MHz	5,7
		5.5V		5.0	3.0	mA HALT Mode $V_{IN} = 0V$ , $V_{CC}$ @ 8 MHz	5,7
		4.5V		7.0	4.0	mA HALT Mode $V_{IN} = 0V$ , $V_{CC}$ @ 12 MHz	5,7
		5.5V		7.0	4.0	mA HALT Mode $V_{IN} = 0V$ , $V_{CC}$ @ 12 MHz	5,7
$I_{CC}$	Supply Current (Low Noise Mode)	4.5V		11.0	6.8	mA All Output and I/O Pins Floating @ 1 MHz	7
		5.5V		11.0	6.8	mA All Output and I/O Pins Floating @ 1 MHz	7
		4.5V		13.0	7.5	mA All Output and I/O Pins Floating @ 2 MHz	7
		5.5V		13.0	7.5	mA All Output and I/O Pins Floating @ 2 MHz	7
		4.5V		15.0	8.2	mA All Output and I/O Pins Floating @ 4 MHz	7
		5.5V		15.0	8.2	mA All Output and I/O Pins Floating @ 4 MHz	7

## DC ELECTRICAL CHARACTERISTICS (Continued)

Sym	Parameter	V <sub>CC</sub> [4]	T <sub>A</sub> = 0°C to +70°C		Typical @ 25°C	Units	Conditions	Notes
			Min	Max				
I <sub>CC1</sub>	Standby Current (Low Noise Mode)	4.5V		4.0	2.5	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 1 MHz	7
		5.5V		4.0	2.5	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 1 MHz	7
		4.5V		4.5	2.8	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 2 MHz	7
		5.5V		4.5	2.8	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 2 MHz	7
		4.5V		5.0	3.0	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 4 MHz	7
		5.5V		5.0	3.0	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 4 MHz	7
I <sub>CC2</sub>	Standby Current	4.5V		10.0	1.0	μA	STOP Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> WDT is not Running	7,8
		5.5V		10.0	1.0	μA	STOP Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> WDT is not Running	7,8
I <sub>ALL</sub>	Auto Latch Low Current	4.5V		32.0	16	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
		5.5V		32.0	16	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
I <sub>ALH</sub>	Auto Latch High Current	4.5V		-16.0	-8.0	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
		5.5V		-16.0	-8.0	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	

## Notes:

- Port 2 and Port 0 only
- V<sub>SS</sub> = 0V = GND
- The device operates down to V<sub>LV</sub> of the specified frequency for V<sub>LV</sub>. The minimum operational V<sub>CC</sub> is determined on the value of the voltage V<sub>LV</sub> at the ambient temperature. The V<sub>LV</sub> increases as the temperature decreases.
- V<sub>CC</sub> = 4.5 to 5.5V, typical values measured at V<sub>CC</sub> = 5.0V.  
The V<sub>CC</sub> voltage specification of 5.5 V guarantees 5.0 V ± 0.5V with typical values measured at V<sub>CC</sub> = 5.0V.
- Standard Mode (not Low EMI Mode)
- Z86E08 only
- All outputs unloaded and all inputs are at V<sub>CC</sub> or V<sub>SS</sub> level.
- If analog comparator is selected, then the comparator inputs must be at V<sub>CC</sub> level.

Sym	Parameter	V <sub>CC</sub> [4]	T <sub>A</sub> = -40°C to +105°C		Typical @ 25°C	Units	Conditions	Notes
			Min	Max				
I <sub>CC1</sub>	Standby Current (Low Noise Mode)	4.5V		4.0	2.5	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 1 MHz	7
		5.5V		4.0	2.5	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 1 MHz	7
		4.5V		4.5	2.8	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 2 MHz	7
		5.5V		4.5	2.8	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 2 MHz	7
		4.5V		5.0	3.0	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 4 MHz	7
		5.5V		5.0	3.0	mA	HALT Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> @ 4 MHz	7
I <sub>CC2</sub>	Standby Current	4.5V		20	1.0	μA	STOP Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> WDT is not Running	7,8
		5.5V		20	1.0	μA	STOP Mode V <sub>IN</sub> = 0V, V <sub>CC</sub> WDT is not Running	7,8
I <sub>ALL</sub>	Auto Latch Low Current	4.5V		40	16	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
		5.5V		40	16	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
I <sub>ALH</sub>	Auto Latch High Current	4.5V		-20.0	-8.0	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	
		5.5V		-20.0	-8.0	μA	0V < V <sub>IN</sub> < V <sub>CC</sub>	

**Notes:**

1. Port 2 and Port 0 only
2. V<sub>SS</sub> = 0V = GND
3. The device operates down to V<sub>LV</sub> of the specified frequency for V<sub>LV</sub>. The minimum operational V<sub>CC</sub> is determined on the value of the voltage V<sub>LV</sub> at the ambient temperature. The V<sub>LV</sub> increases as the temperature decreases.
4. V<sub>CC</sub> = 4.5V to 5.5V, typical values measured at V<sub>CC</sub> = 5.0V
5. Standard Mode (not Low EMI Mode)
6. Z86E08 only
7. All outputs unloaded and all inputs are at V<sub>CC</sub> or V<sub>SS</sub> level.
8. If analog comparator is selected, then the comparator inputs must be at V<sub>CC</sub> level.

## AC ELECTRICAL CHARACTERISTICS

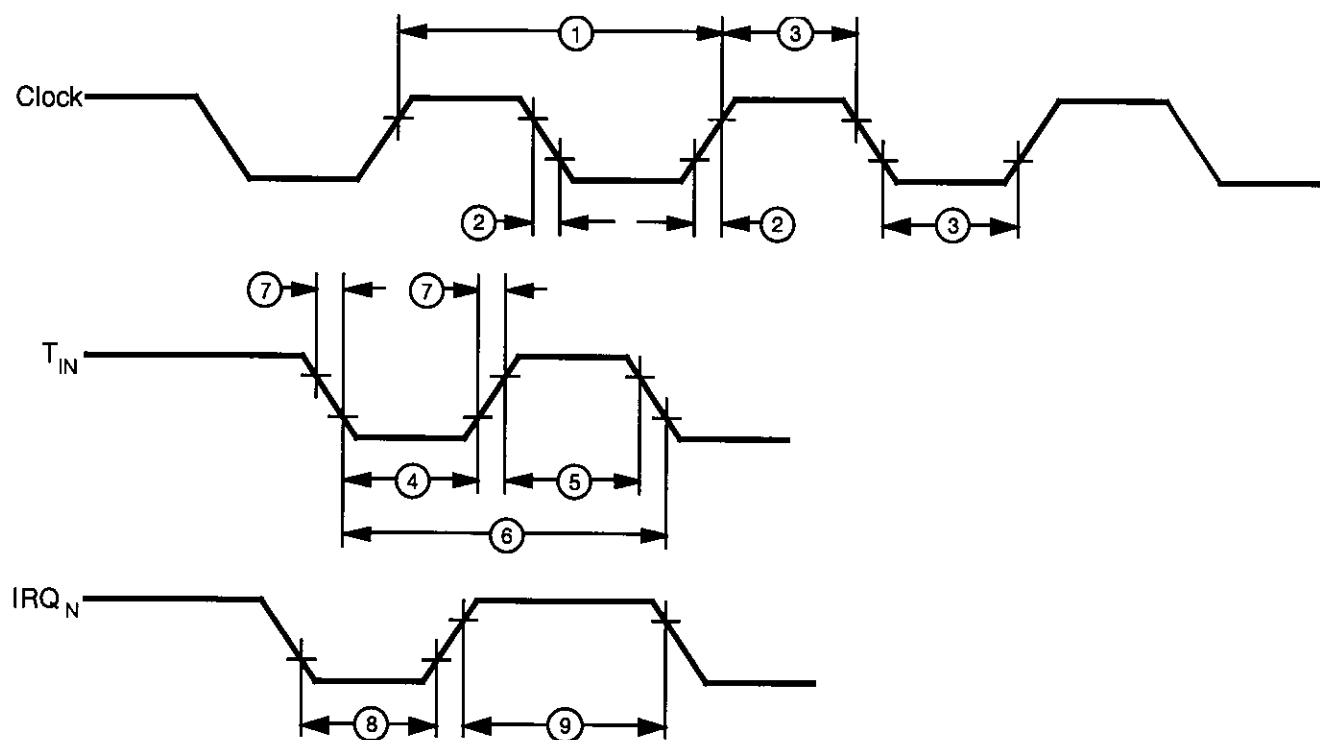


Figure 6. AC Electrical Timing Diagram

**AC ELECTRICAL CHARACTERISTICS**

Low Noise Mode, Standard Temperature

No	Symbol	Parameter	V <sub>CC</sub>	T <sub>A</sub> = 0 °C to +70 °C				Units	Notes
				1 MHz		4 MHz			
				Min	Max	Min	Max		
1	TPC	Input Clock Period	4.5V	1000	DC	250	DC	ns	1
			5.5V	1000	DC	250	DC	ns	1
2	TrC TfC	Clock Input Rise and Fall Times	4.5V		25		25	ns	1
			5.5V		25		25	ns	1
3	TwC	Input Clock Width	4.5V	500		125		ns	1
			5.5V	500		125		ns	1
4.	TwTinL	Timer Input Low Width	4.5V	70		70		ns	1
			5.5V	70		70		ns	1
5	TwTinH	Timer Input High Width	4.5V	2.5TpC		2.5TpC			1
			5.5V	2.5TpC		2.5TpC			1
6	TpTin	Timer Input Period	4.5V	4TpC		4TpC			1
			5.5V	4TpC		4TpC			1
7	TrTin, TtTin	Timer Input Rise and Fall Time	4.5V		100		100	ns	1
			5.5V		100		100	ns	1
8	TwIL Low Time	Int. Request Input	4.5V	70		70		ns	1,2
			5.5V	70		70		ns	1,2
9	TwIH High Time	Int. Request Input	4.5V	2.5TpC		2.5TpC			1,2
			5.5V	2.5TpC		2.5TpC			1,2
10	Twdt	Watch-Dog Timer Delay Time for Timeout	4.5V	12		12		ms	1
			5.5V	12		12		ms	1

**Notes:**

1. Timing Reference uses 0.7 V<sub>CC</sub> for a logic 1 and 0.2 V<sub>CC</sub> for a logic 0.
2. Interrupt request through Port 3 (P33–P31).



## LOW NOISE VERSION

### Low EMI Emission

The Z86E04/E08 can be programmed to operate in a Low EMI Emission Mode by means of a mask ROM bit option. Use of this feature results in:

- All pre-driver slew rates reduced to 10 ns typical.
- Internal SCLK/TCLK operation limited to a maximum of 4 MHz–250 ns cycle time.

- Output drivers have resistances of 500 Ohms (typical).
- Oscillator divide-by-two circuitry eliminated.

The Low EMI Mode is mask-programmable to be selected by the customer at the time the ROM code is submitted.

## PIN FUNCTIONS

### OTP Programming Mode

**D7–D0 Data Bus.** Data can be read from, or written to, the EPROM through this data bus.

**V<sub>CC</sub> Power Supply.** It is typically 5V during EPROM Read Mode and 6.4V during the other modes (Program, Program Verify, and so on).

**$\overline{CE}$  Chip Enable (active Low).** This pin is active during EPROM Read Mode, Program Mode, and Program Verify Mode.

**$\overline{OE}$  Output Enable (active Low).** This pin drives the Data Bus direction. When this pin is Low, the Data Bus is output. When High, the Data Bus is input.

**EPM EPROM Program Mode.** This pin controls the different EPROM Program Modes by applying different voltages.

**V<sub>PP</sub> Program Voltage.** This pin supplies the program voltage.

**Clear Clear (active High).** This pin resets the internal address counter at the High Level.

**Clock Address Clock.** This pin is a clock input. The internal address counter increases by one with one clock cycle.

**PGM Program Mode (active Low).** A Low level at this pin programs the data to the EPROM through the Data Bus.

### Application Precaution

The production test-mode environment may be enabled accidentally during normal operation if **excessive noise** surges above V<sub>CC</sub> occur on the XTAL1 pin.

In addition, processor operation of Z8 OTP devices may be affected by **excessive noise** surges on the V<sub>PP</sub>,  $\overline{CE}$ , EPM,  $\overline{OE}$  pins while the microcontroller is in Standard Mode.

Recommendations for dampening voltage surges in both test and OTP Mode include the following:

- Using a clamping diode to V<sub>CC</sub>.
- Adding a capacitor to the affected pin.

**Note:** Programming the EPROM/Test Mode Disable option will prevent accidental entry into EPROM Mode or Test Mode.

**Port 2, P27–P20.** Port 2 is an 8-bit, bit programmable, bi-directional, Schmitt-triggered CMOS-compatible I/O port. These eight I/O lines can be configured under software

control to be inputs or outputs, independently. Bits programmed as outputs can be globally programmed as either push-pull or open-drain (Figure 8).

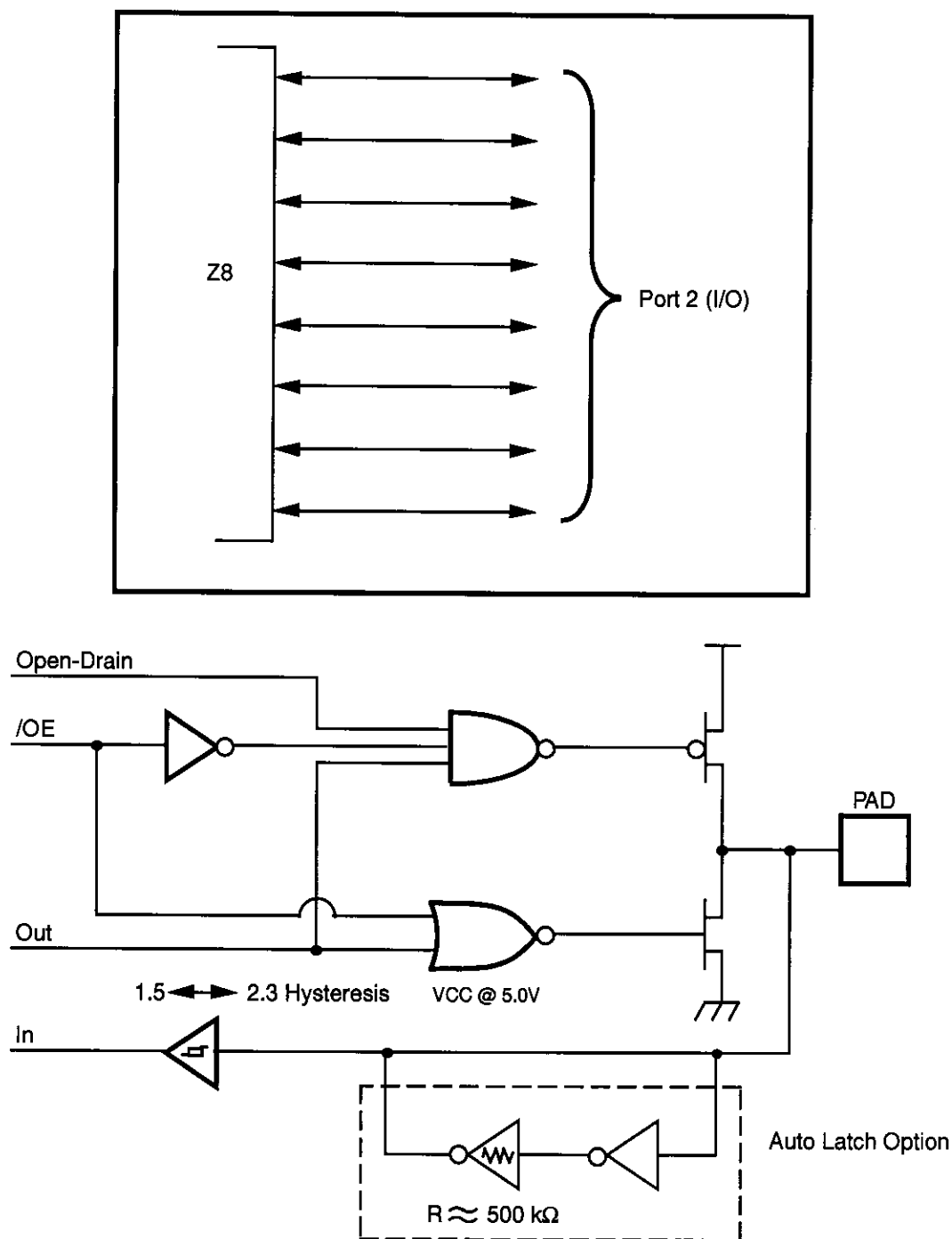
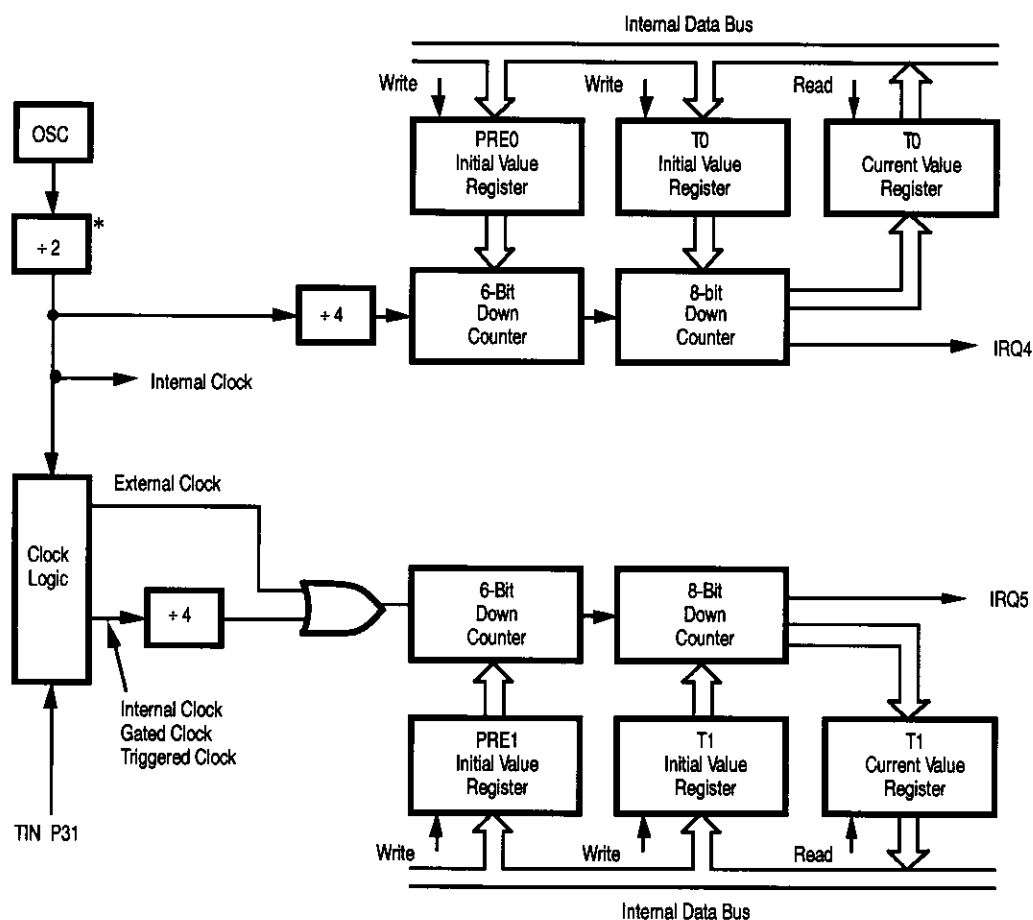


Figure 8. Port 2 Configuration



\* Note: By passed, if Low EMI Mode is selected.

Figure 14. Counter/Timers Block Diagram

## FUNCTIONAL DESCRIPTION (Continued)

**Interrupts.** The Z8 has six interrupts from six different sources. These interrupts are maskable and prioritized (Figure 15). The sources are divided as follows: the falling edge of P31 (AN1), P32 (AN2), P33 (REF), the rising edge of P32 (AN2), and two counter/timers. The Interrupt Mask Register globally or individually enables or disables the six interrupt requests (Table 4).

When more than one interrupt is pending, priorities are resolved by a programmable priority encoder that is controlled by the Interrupt Priority register. All Z8 interrupts are vectored through locations in program memory. When an Interrupt machine cycle is activated, an Interrupt Request is granted. This disables all subsequent interrupts, saves the Program Counter and Status Flags, and then branches to the program memory vector location reserved for that interrupt. This memory location and the next byte contain the 16-bit starting address of the interrupt service routine for that particular interrupt request.

To accommodate polled interrupt systems, interrupt inputs are masked and the interrupt request register is polled to determine which of the interrupt requests needs service.

**Note:** User must select any Z86E08 mode in Zilog's C12 ICEBOX™ emulator. The rising edge interrupt is not supported on the CCP emulator (a hardware/software workaround must be employed).

Table 4. Interrupt Types, Sources, and Vectors

Name	Source	Vector Location	Comments
IRQ0	AN2(P32)	0,1	External (F)Edge
IRQ1	REF(P33)	2,3	External (F)Edge
IRQ2	AN1(P31)	4,5	External (F)Edge
IRQ3	AN2(P32)	6,7	External (R)Edge
IRQ4	T0	8,9	Internal
IRQ5	T1	10,11	Internal

**Notes:**

F = Falling edge triggered

R = Rising edge triggered

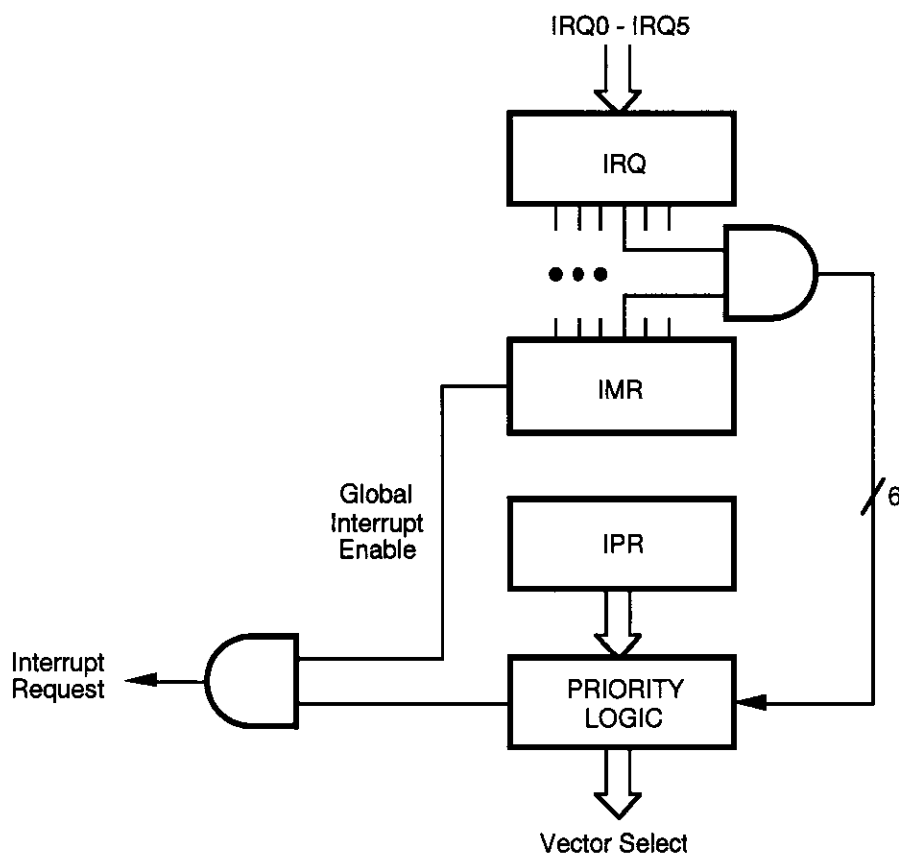
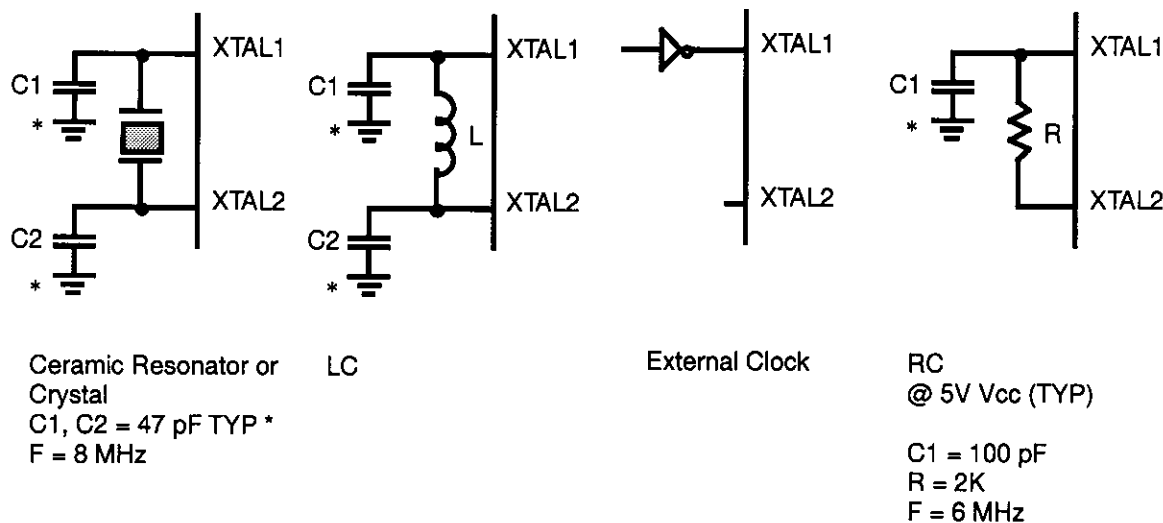


Figure 15. Interrupt Block Diagram

**Clock.** The Z8 on-chip oscillator has a high-gain, parallel-resonant amplifier for connection to a crystal, LC, RC, ceramic resonator, or any suitable external clock source (XTAL1 = INPUT, XTAL2 = OUTPUT). The crystal should be AT cut, up to 12 MHz max., with a series resistance (RS) of less than or equal to 100 Ohms.

The crystal should be connected across XTAL1 and XTAL2 using the vendors crystal recommended capacitors from each pin directly to device ground pin 14 (Figure 16). Note that the crystal capacitor loads should be connected to  $V_{SS}$ , Pin 14 to reduce Ground noise injection.



\* Typical value including pin parasitics

**Figure 16. Oscillator Configuration**

FUNCTIONAL DESCRIPTION (Continued)

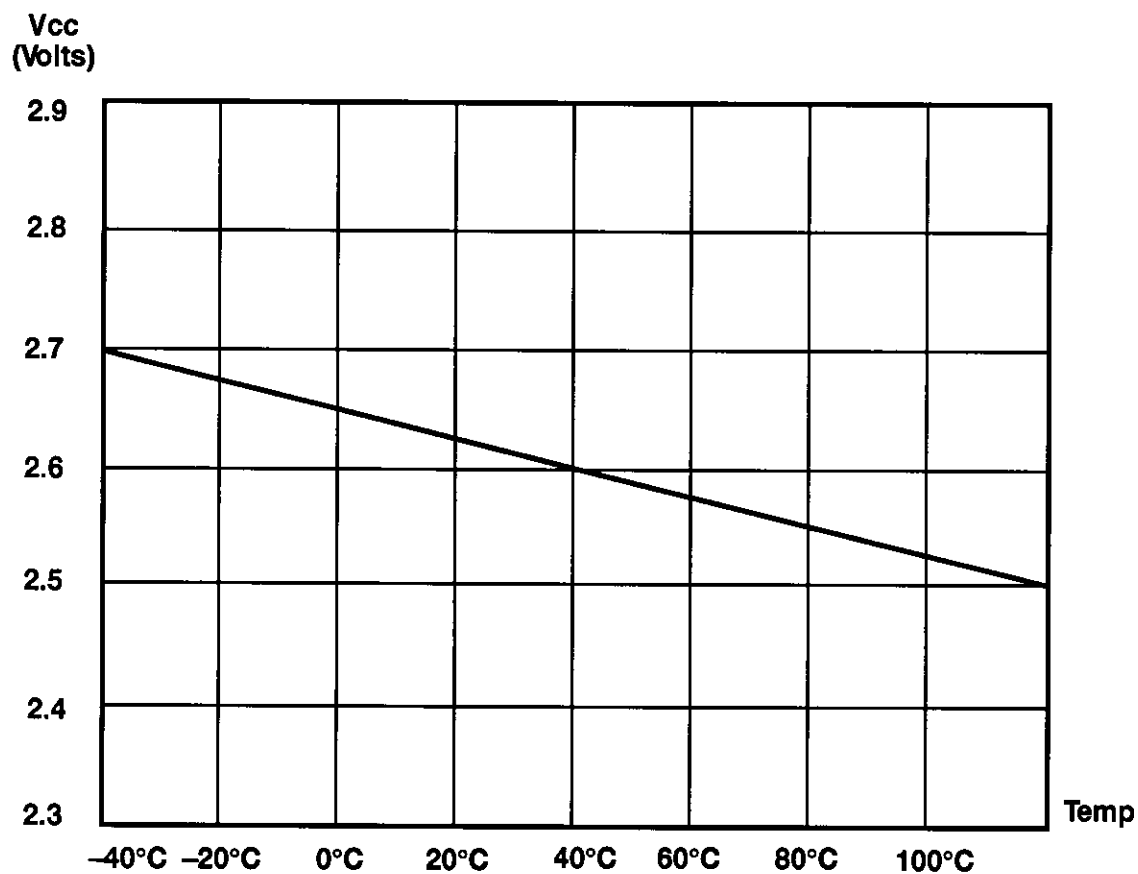
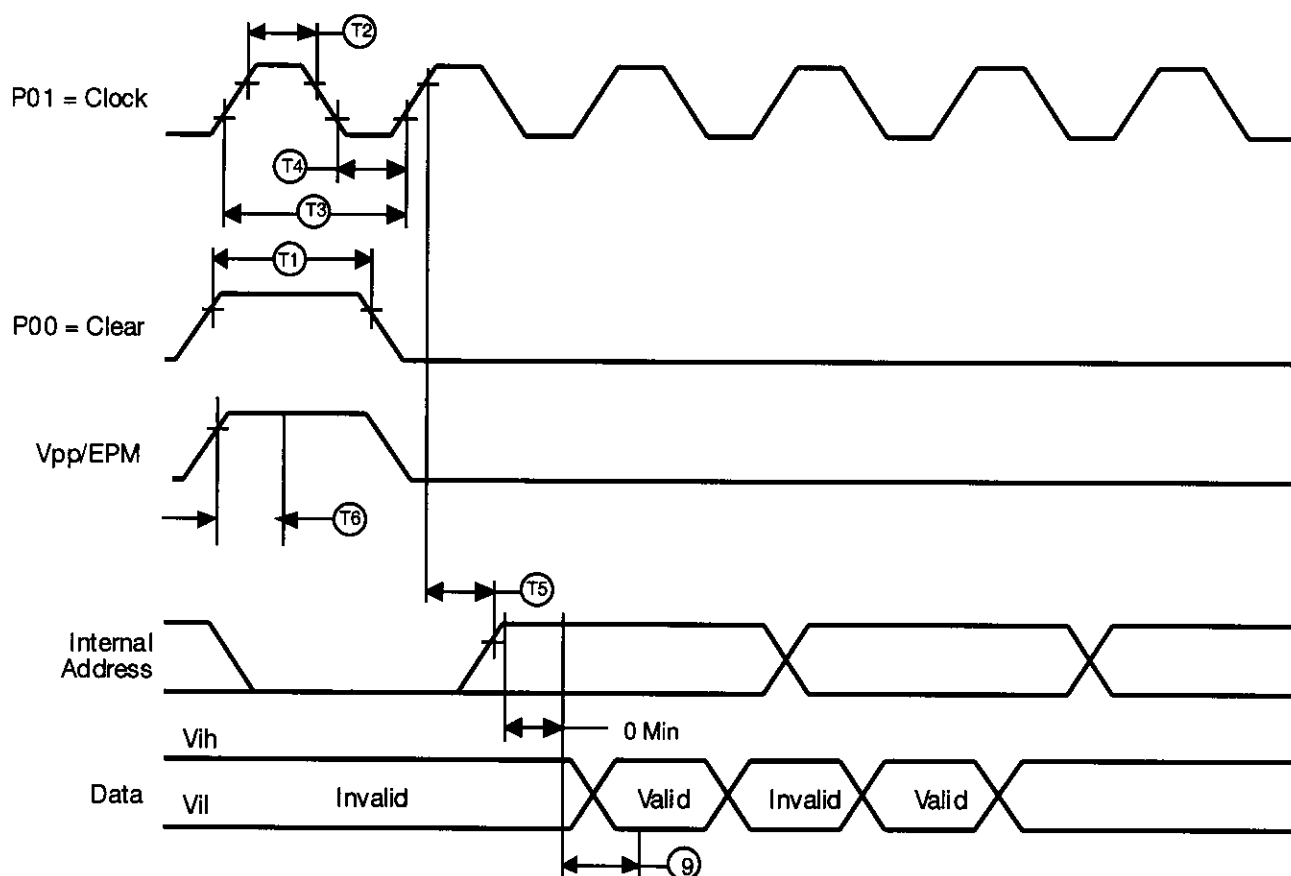


Figure 17. Typical Auto Reset Voltage  
( $V_{LV}$ ) vs. Temperature



Legend:	
T1 Reset Clock Width	30 ns Min
T2 Input Clock High	100 ns Min
T3 Input Clock Period	200 ns Min
T4 Input Clock Low	100 ns Min
T5 Clock to Address Counter Out Delay	15 ns Max
T6 Epm/Vpp Set up Time	40 $\mu$ s Min

Figure 18. Z86E04/E08 Address Counter Waveform

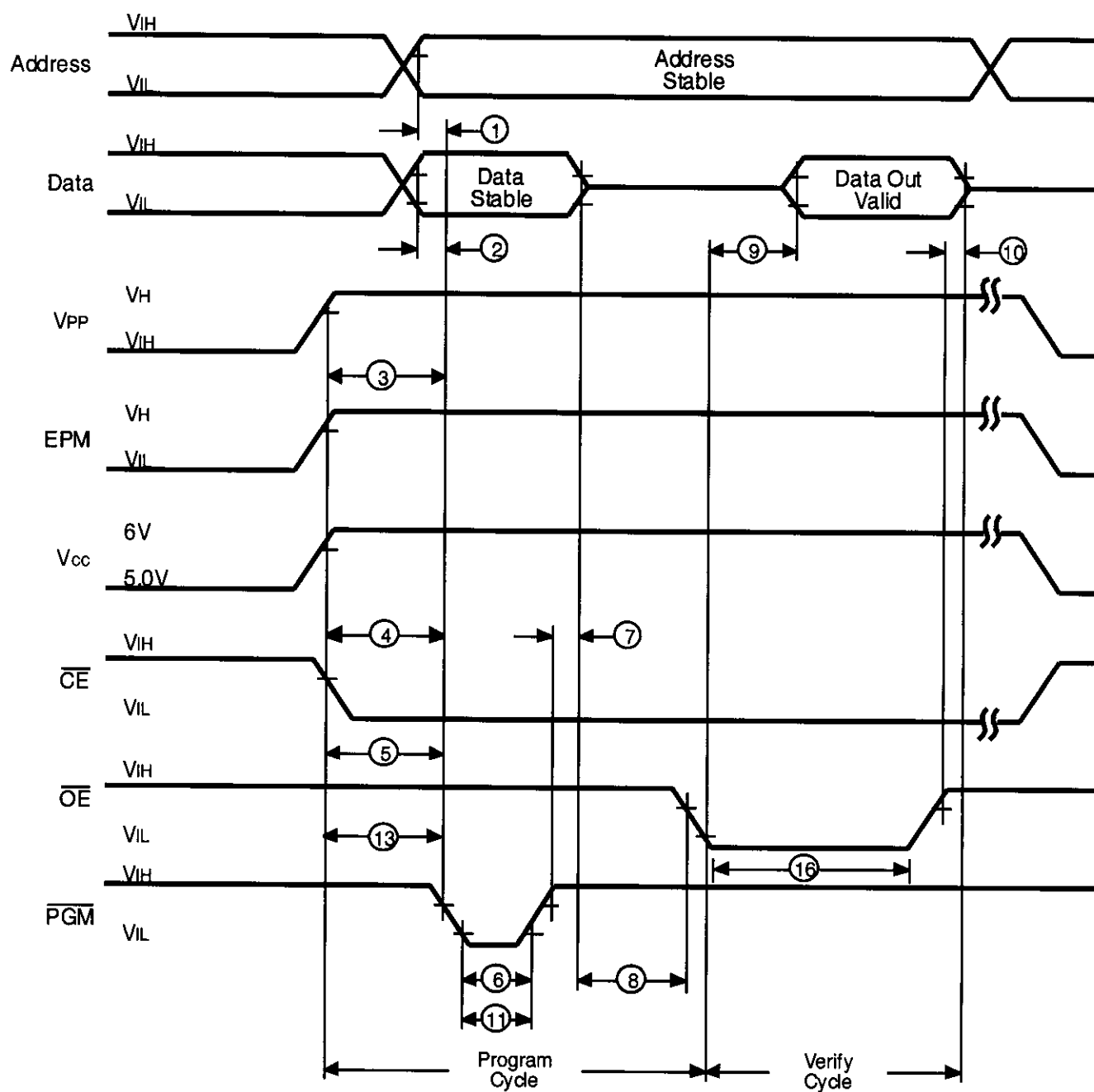
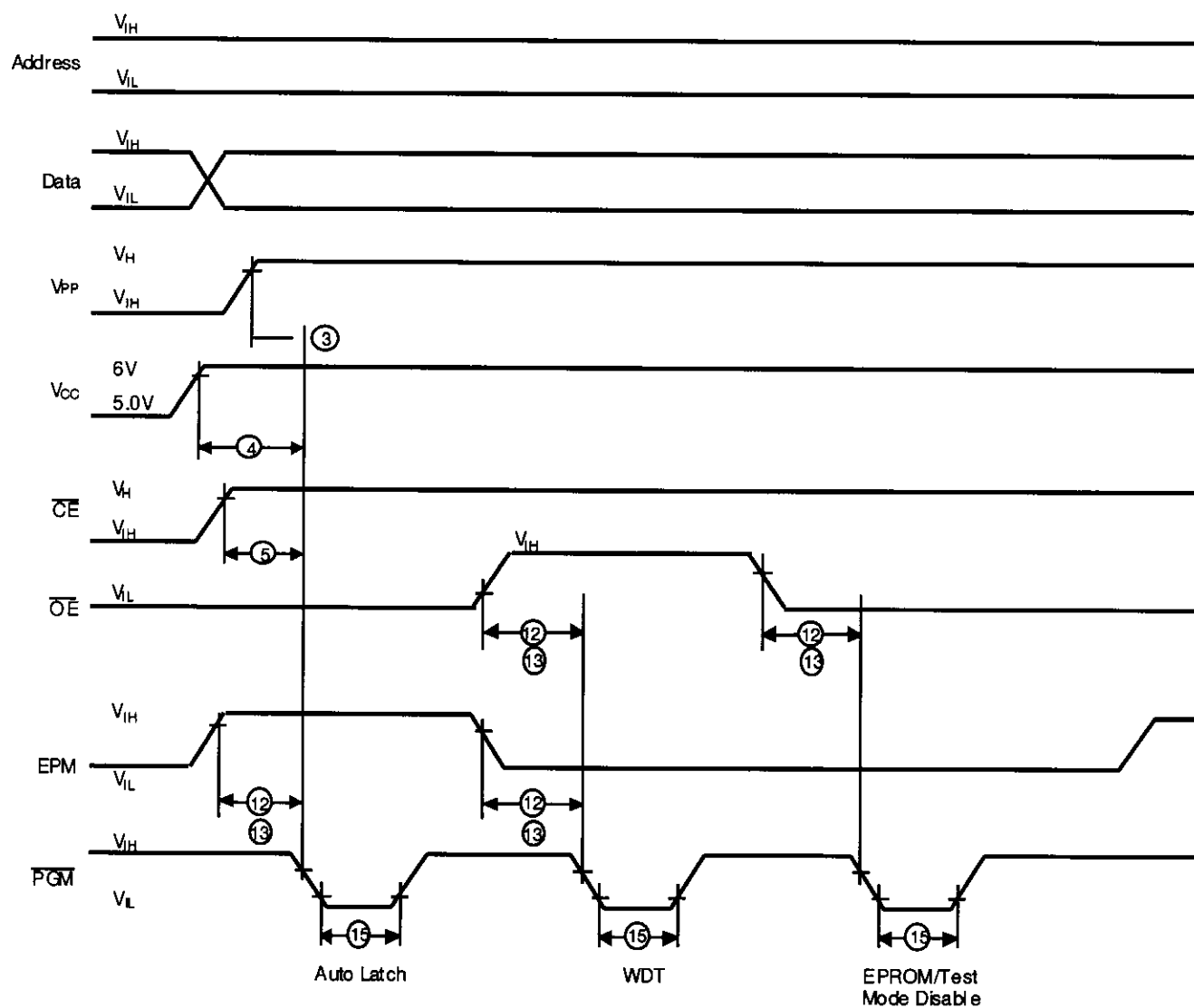


Figure 20. Z86E04/E08 Programming Waveform  
(Program and Verify)





**Figure 22. Z86E04/E08 Programming Options Waveform  
(Auto Latch Disable, Permanent WDT Enable and  
EPROM/Test Mode Disable)**

# FUNCTIONAL DESCRIPTION (Continued)

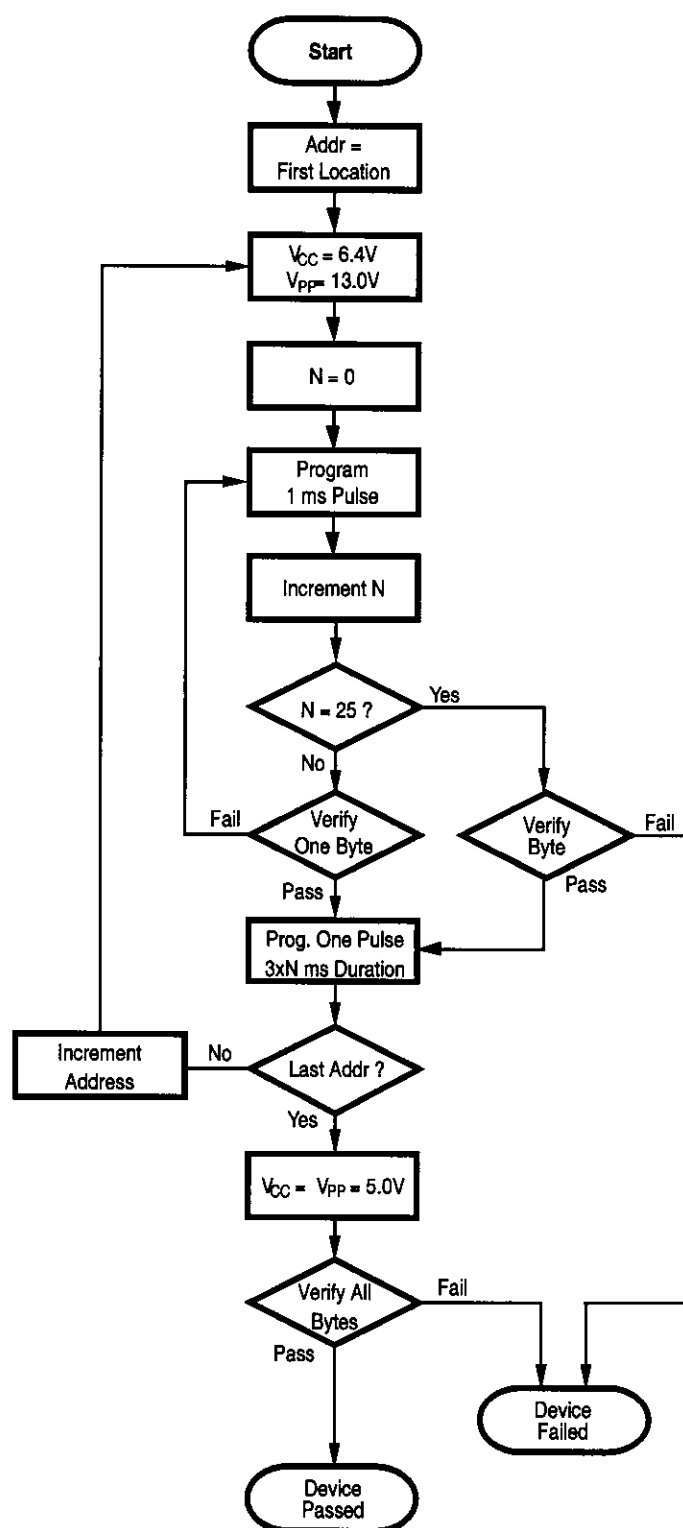
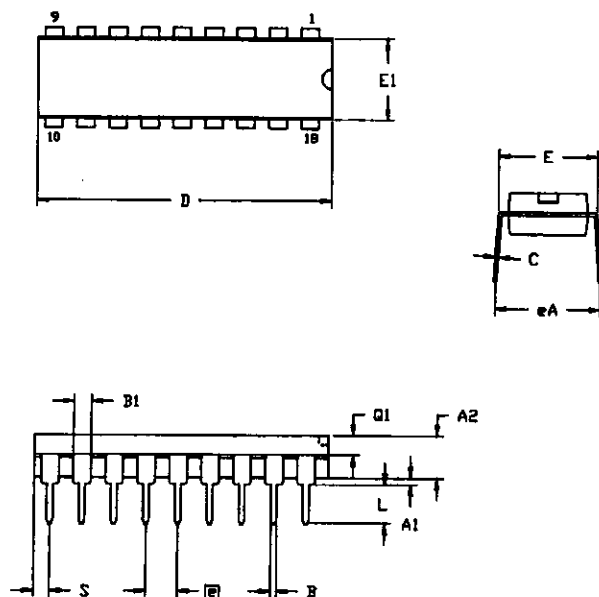


Figure 23. Z86E04/E08 Programming Algorithm

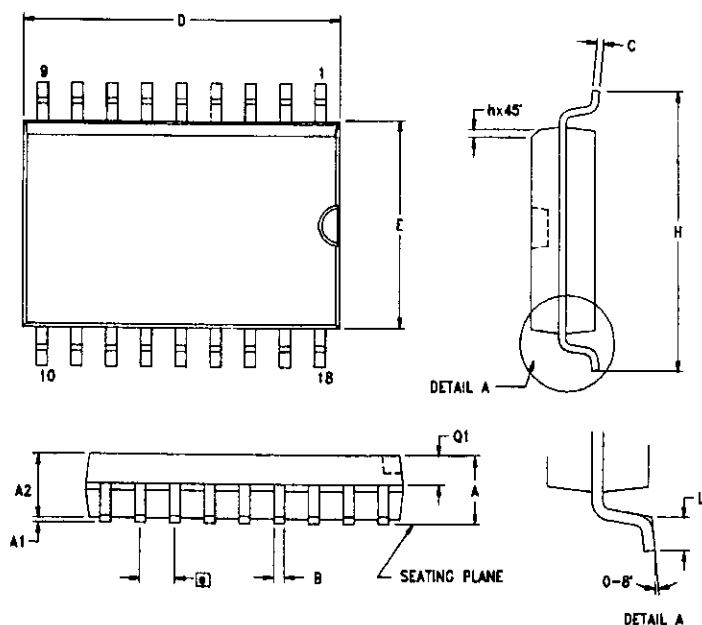
## PACKAGE INFORMATION



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A1	0.51	0.81	.020	.032
A2	3.25	3.43	.128	.135
B	0.38	0.53	.015	.021
B1	1.14	1.65	.045	.065
C	0.23	0.38	.009	.015
D	22.35	23.37	.880	.920
E	7.62	8.13	.300	.320
E1	6.22	6.48	.245	.255
□	2.54 TYP		.100 TYP	
eA	7.87	8.89	.310	.350
L	3.18	3.81	.125	.150
Q1	1.52	1.65	.060	.065
S	0.89	1.65	.035	.065

CONTROLLING DIMENSIONS : INCH

18-Pin DIP Package Diagram



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	2.40	2.65	0.094	0.104
A1	0.10	0.30	0.004	0.012
A2	2.24	2.44	0.088	0.096
B	0.36	0.46	0.014	0.018
C	0.23	0.30	0.009	0.012
D	11.40	11.75	0.449	0.463
E	7.40	7.60	0.291	0.299
□	1.27 TYP		0.050 TYP	
H	10.00	10.65	0.394	0.419
h	0.30	0.50	0.012	0.020
L	0.60	1.00	0.024	0.039
Q1	0.97	1.07	0.038	0.042

CONTROLLING DIMENSIONS : MM  
LEADS ARE COPLANAR WITHIN .004 INCH.

18-Pin SOIC Package Diagram

## ORDERING INFORMATION

### Z86E04

#### Standard Temperature

18-Pin DIP	18-Pin SOIC
Z86E0412PSC	Z86E0412SSC
Z86E0412PEC	Z86E0412SEC

### Z86E08

#### Standard Temperature

18-Pin DIP	18-Pin SOIC
Z86E0812PSC	Z86E0812SSC
Z86E0812PEC	Z86E0812SEC

For fast results, contact your local Zilog sales office for assistance in ordering the part(s) desired.

## Codes

### Preferred Package

P = Plastic DIP

### Speeds

12 = 12 MHz

### Longer Lead Time

S = SOIC

### Environmental

C = Plastic Standard

### Preferred Temperature

S = 0°C to +70°C

E = -40°C to +105°C

### Example:

**Z 86E04 12 P S C** is a Z86E04, 12 MHz, DIP, 0°C to +70°C, Plastic Standard Flow

The diagram illustrates the structure of the part number 'Z 86E04 12 P S C' with lines connecting each segment to its description:

- Z**: Zilog Prefix
- 86E04**: Product Number
- 12**: Speed
- P**: Package
- S**: Temperature
- C**: Environmental Flow

---

**Pre-Characterization Product:**

The product represented by this CPS is newly introduced and Zilog has not completed the full characterization of the product. The CPS states what Zilog knows about this product at this time, but additional features or nonconformance with some aspects of the CPS may be

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